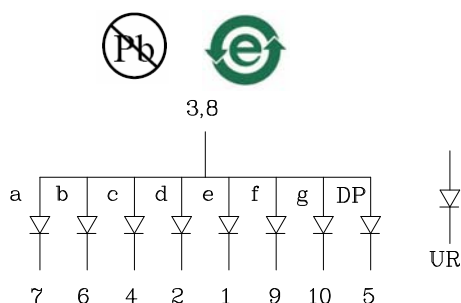


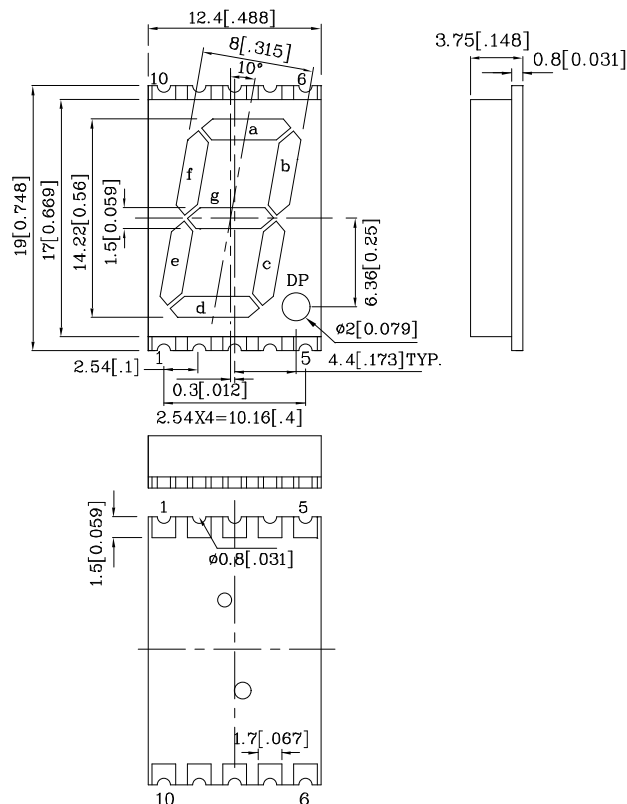
Features

- 0.56 INCH DIGIT HEIGHT.
- LOW CURRENT OPERATION.
- EXCELLENT CHARACTER APPEARANCE.
- I.C. COMPATIBLE.
- MECHANICALLY RUGGED.
- GRAY FACE, WHITE SEGMENT.
- PACKAGE : 400PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 4.
- RoHS COMPLIANT.



Notes:

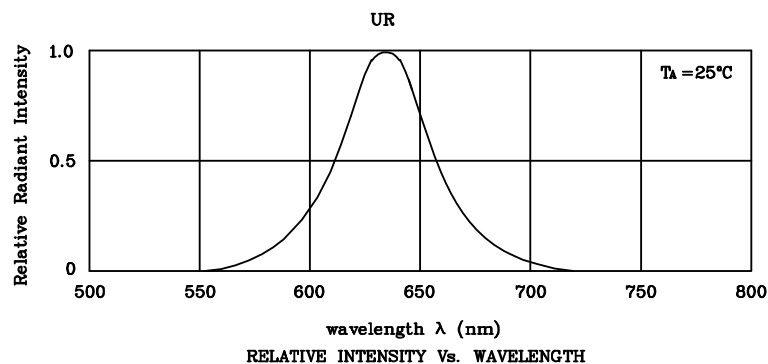
1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01")$ unless otherwise noted.
3. Specifications are subject to change without notice.
4. The gap between the reflector and PCB shall not exceed 0.25mm.



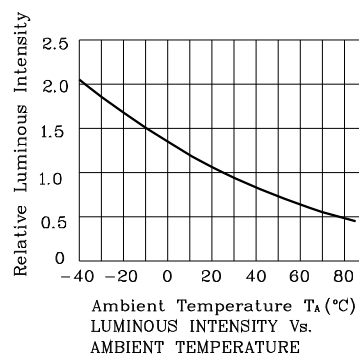
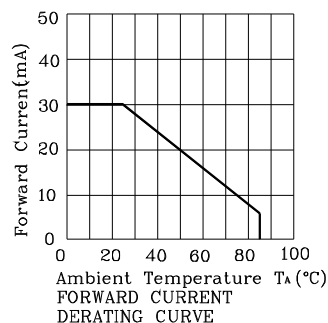
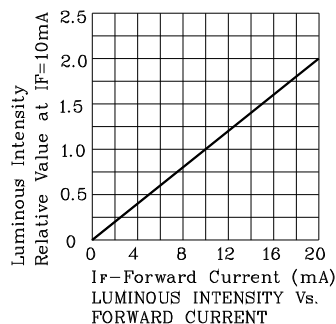
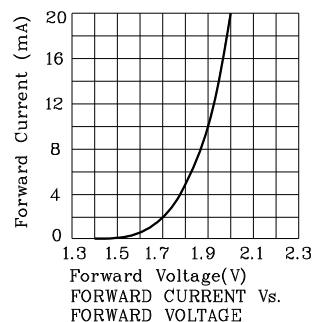
Absolute Maximum Ratings (TA=25°C)		UR (GaAsP/ GaP)	Unit
Reverse Voltage	V _R	5	V
Forward Current	I _F	30	mA
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	i _{FS}	160	mA
Power Dissipation	P _T	75	mW
Operating Temperature	T _A	-40 ~ +85	°C
Storage Temperature	T _{stg}	-40 ~ +85	

Operating Characteristics (TA=25°C)		UR (GaAsP/GaP)	Unit
Forward Voltage (Typ.) (I _F =10mA)	V _F	1.9	V
Forward Voltage (Max.) (I _F =10mA)	V _F	2.5	V
Reverse Current (Max.) (V _R =5V)	I _R	10	uA
Wavelength of Peak Emission (Typ.) (I _F =10mA)	λ _P	627	nm
Wavelength of Dominant Emission (Typ.) (I _F =10mA)	λ _D	625	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	Δλ	45	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (I _F =10mA) ucd	Wavelength nm λ _P	Description
			min.	typ.	
ZFUR14A	Red	GaAsP/GaP	1200	7390	627 Common Anode. Rt. Hand Decimal
Published Date : FEB 29, 2007 Drawing No : SDSA5369 V2 Checked : Shin Chi P.1/4					



❖ **UR**



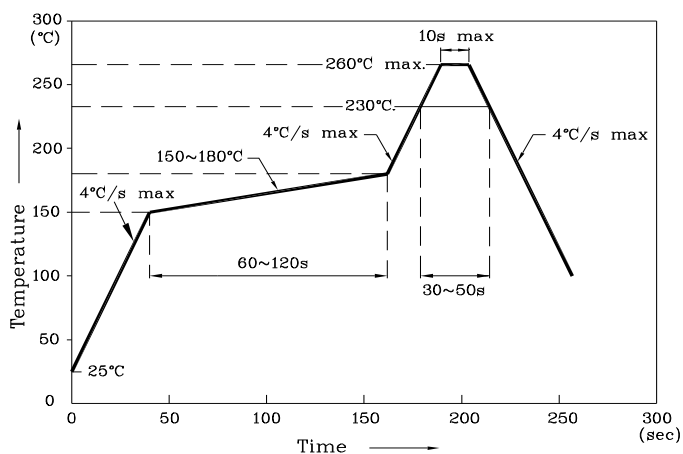
Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: $\pm 1\text{nm}$
2. Luminous Intensity / Luminous Flux: $\pm 15\%$
3. Forward Voltage: $\pm 0.1\text{V}$

Note: Accuracy may depend on the sorting parameters.

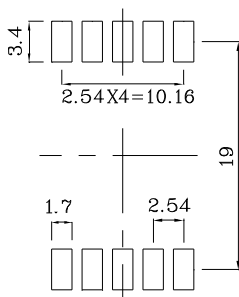
Reflow Soldering Profile For Lead-free SMT Process.



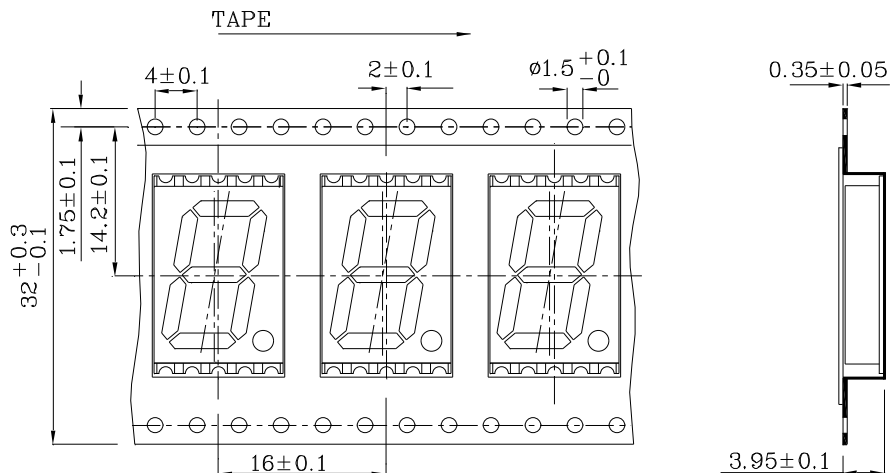
Notes:

- 1.Maximum soldering temperature should not exceed 260°C.
- 2.Recommended reflow temperature: 145°C-260°C.
- 3.Do not put stress to the epoxy resin during high temperatures conditions.

❖ Recommended Soldering Pattern (Units : mm;Tolerance:± 0.15)

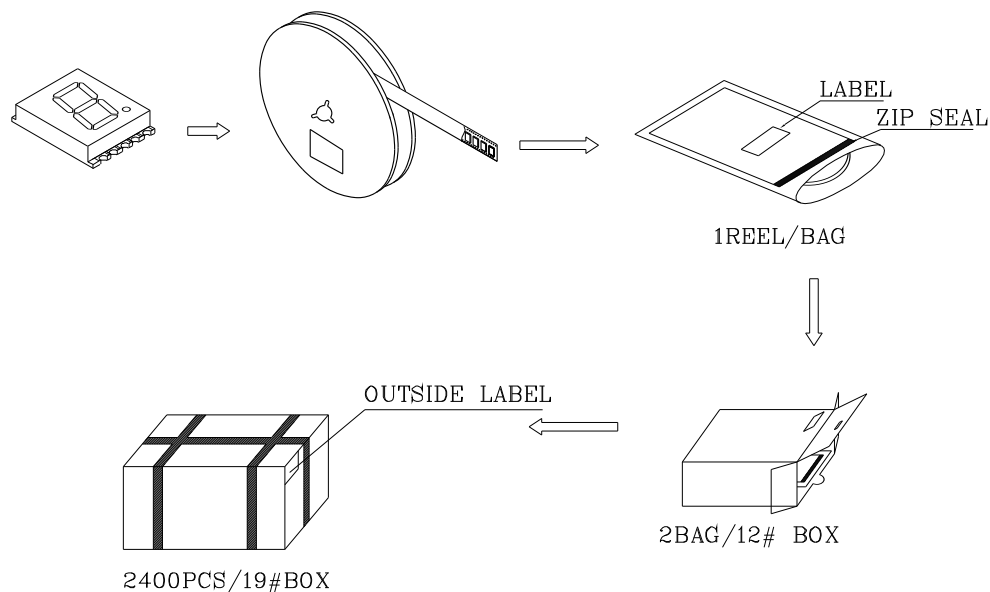


❖ Tape Specification (Units : mm)



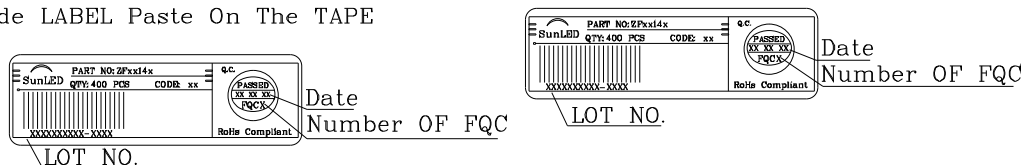
PACKING & LABEL SPECIFICATIONS

ZFUR14A



Outside LABEL Paste On The BAG

Inside LABEL Paste On The TAPE



Outside LABEL Paste On The 19#Box

Outside LABEL Paste On The 12#Box

